

Oral Presentation Award

Presented to:

Meng-Chun Chiu

"Electromigration in Advanced High-power Automobile Interconnects with Ni and Ag Metallizations at Solder/Cu Interfaces"

for the oral presentation at the
"International Student Workshop on Materials Science and Engineering 2023
(ISWMSE 2023)."
December 12th-13th, 2023

Workshop Chairpersons



Prof. Tatsuya Tokunaga
Kyushu Institute of
Technology



Prof. Chien-Lung Liang
National Taiwan University of
Science and Technology



Prof. Jun-Seob Lee
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